MA4ZD14

Silicon epitaxial planar type

For high speed switching

■ Features

- Two isolated elements are contained in one package, allowing high-density mounting
- Low forward voltage: $V_F < 0.40 \text{ V}$

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Reverse voltage		V _R	20	V	
Repetitive peak reverse-voltage		V_{RRM}	20	V	
Forward current	Single	I_{F}	100	mA	
	Double *1		75		
Peak forward	Single	I_{FM}	300	mA	
current	Double *1		225		
Non-repetitive peak	Single	I_{FSM}	1	A	
forward surge current *2	Double *1		0.75		
Junction temperature		T _j	125	°C	
Storage temperature		T_{stg}	-55 to +125	G°C	

Note) *1: Value of each diode in double diodes used.

Package

- Code
 SMini4-F1
- Pin Name

1: Anode 1 3: Cathode 2 2: Anode 2 4: Cathode 1

■ Marking Symbol: M5D

Internal Connection

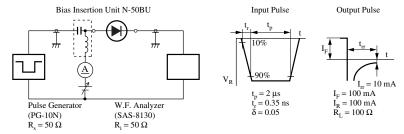


■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

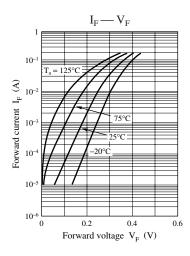
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current	I_R	$V_R = 10 \text{ V}$	1.90		20	μΑ
Forward voltage	V_{F1}	$I_F = 5 \text{ mA}$			0.27	V
	V_{F2}	I _F = 100 mA			0.40	
Terminal capacitance	Ct	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$		25		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}$		3		ns
		$I_{rr} = 10 \text{ mA}, R_{L} = 100 \Omega$				

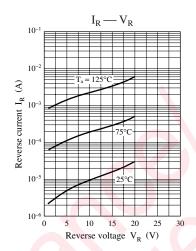
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 250 MHz.

4.*: t_{rr} measurement circuit



^{*2:} The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)





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